

MOSFET

650 V CoolSiC™ M1 SiC Trench Power Device

The 650 V CoolSiC™ is built over the solid silicon carbide technology developed in Infineon in more than 20 years. Leveraging the wide bandgap SiC material characteristics, the 650V CoolSiC™ MOSFET offers a unique combination of performance, reliability and ease of use. Suitable for high temperature and harsh operations, it enables the simplified and cost effective deployment of the highest system efficiency.

Features

- Optimized switching behavior at higher currents
- Commutation robust fast body diode with low Q_{rr}
- Superior gate oxide reliability
- $T_{j,max}=175^{\circ}\text{C}$ and excellent thermal behavior
- Lower $R_{DS(on)}$ and pulse current dependency on temperature
- Increased avalanche capability
- Compatible with standard drivers (recommended driving voltage: 18V)
- Kelvin source provides up to 4 times lower switching losses

Benefits

- Unique combination of high performance, high reliability and ease of use
- Ease of use and integration
- Suitable for topologies with continuous hard commutation
- Higher robustness and system reliability
- Efficiency improvement
- Reduced system size leading to higher power density

Potential applications

- SMPS
- UPS (uninterruptable power supplies)
- Solar PV inverters
- EV charging infrastructure
- Energy storage and battery formation
- Class D amplifiers

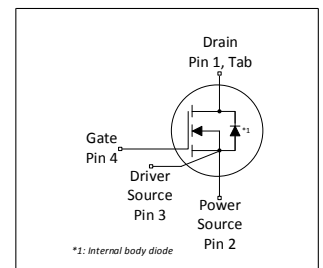
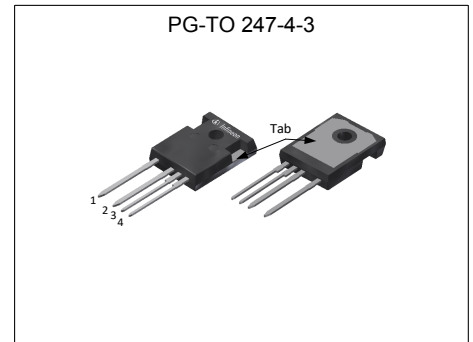
Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: The source and driver source pins are not exchangeable. Their exchange might lead to malfunction.

Table 1 Key Performance Parameters

Parameter	Value	Unit
$V_{DS} @ T_J = 25^{\circ}\text{C}$	650	V
$R_{DS(on),typ}$	30	mΩ
$R_{DS(on),max}$	42	mΩ
$Q_{G,typ}$	48	nC
$I_{D,pulse}$	143	A
$Q_{oss} @ 400\text{ V}$	114	nC
$E_{oss} @ 400\text{ V}$	17.2	μJ



RoHS

Type / Ordering Code	Package	Marking	Related Links
IMZA65R030M1H	PG-TO247-4-3	65R030M1	see Appendix A

Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	5
Electrical characteristics diagrams	7
Test Circuits	12
Package Outlines	13
Appendix A	14
Revision History	15
Trademarks	15
Disclaimer	15

1 Maximum ratings

at $T_J = 25\text{ °C}$, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current ¹⁾	I_D	-	-	53 41	A	$T_C = 25\text{ °C}$ $T_C = 100\text{ °C}$
Pulsed drain current ²⁾	$I_{D,pulse}$	-	-	143	A	$T_C = 25\text{ °C}$
Avalanche energy, single pulse	E_{AS}	-	-	251	mJ	$I_D = 9.4\text{ A}$, $V_{DD} = 50\text{ V}$, $L = 5.7\text{ mH}$; see table 10
Avalanche energy, repetitive	E_{AR}	-	-	1.26	mJ	$I_D = 9.4\text{ A}$, $V_{DD} = 50\text{ V}$; see table 10
Avalanche current, single pulse	I_{AS}	-	-	9.4	A	-
MOSFET dv/dt ruggedness	dv/dt	-	-	200	V/ns	$V_{DS} = 0...400\text{ V}$
Gate source voltage (static)	V_{GS}	-2	-	20	V	static
Gate source voltage (recommended driving voltage)	V_{GS}	0	-	18	V	-
Gate source voltage (dynamic)	V_{GS}	-5	-	23	V	$t_{pulse,negative} \leq 15\text{ ns}$ $t_{pulse,positive} \leq 1\% \text{ duty cycle}/f_{sw}$
Power dissipation	P_{tot}	-	-	197	W	$T_C = 25\text{ °C}$
Storage temperature	T_{stg}	-55	-	150	°C	-
Operating junction temperature	T_J	-55	-	175	°C	-
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws
Continuous diode forward current ¹⁾	I_S	-	-	53	A	$T_C = 25\text{ °C}$
Diode pulse current ²⁾	$I_{S,pulse}$	-	-	143	A	$T_C = 25\text{ °C}$
Insulation withstand voltage	V_{ISO}	-	-	n.a.	V	V_{rms} , $T_C = 25\text{ °C}$, $t = 1\text{ min}$

¹⁾ Limited by $T_{J,max}$

²⁾ Pulse width t_p limited by $T_{J,max}$

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	0.76	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	leaded
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	-	-	°C/W	n.a.
Soldering temperature, wavesoldering only allowed at leads	T_{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s

3 Electrical characteristics

at $T_J = 25\text{ °C}$, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	650	-	-	V	$V_{GS} = 0\text{ V}$, $I_D = 0.88\text{ mA}$
Gate threshold voltage ¹⁾	$V_{(GS)th}$	3.5	4.5	5.7	V	$V_{DS} = V_{GS}$, $I_D = 8.8\text{ mA}$
Zero gate voltage drain current	I_{DSS}	-	1 3	150 -	μA	$V_{DS} = 650\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 25\text{ °C}$ $V_{DS} = 650\text{ V}$, $V_{GS} = 0\text{ V}$, $T_J = 175\text{ °C}$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS} = 20\text{ V}$, $V_{DS} = 0\text{ V}$
Drain-source on-state resistance	$R_{DS(on)}$	-	0.030 0.042	0.042 -	Ω	$V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $T_J = 25\text{ °C}$ $V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $T_J = 175\text{ °C}$
Gate resistance	R_G	-	5.0	-	Ω	$f = 1\text{ MHz}$, open drain

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	1643	-	pF	$V_{GS} = 0\text{ V}$, $V_{DS} = 400\text{ V}$, $f = 250\text{ kHz}$
Reverse capacitance	C_{riss}	-	18	-	pF	$V_{GS} = 0\text{ V}$, $V_{DS} = 400\text{ V}$, $f = 250\text{ kHz}$
Output capacitance ²⁾	C_{oss}	-	189	246	pF	$V_{GS} = 0\text{ V}$, $V_{DS} = 400\text{ V}$, $f = 250\text{ kHz}$
Output charge ²⁾	Q_{oss}	-	114	148	nC	calculation based on C_{oss}
Effective output capacitance, energy related ³⁾	$C_{o(er)}$	-	214	-	pF	$V_{GS} = 0\text{ V}$, $V_{DS} = 0\dots 400\text{ V}$
Effective output capacitance, time related ⁴⁾	$C_{o(tr)}$	-	284	-	pF	$I_D = \text{constant}$, $V_{GS} = 0\text{ V}$, $V_{DS} = 0\dots 400\text{ V}$
Turn-on delay time	$t_{d(on)}$	-	11.6	-	ns	$V_{DD} = 400\text{ V}$, $V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $R_G = 1.8\text{ }\Omega$; see table 9
Rise time	t_r	-	11.3	-	ns	$V_{DD} = 400\text{ V}$, $V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $R_G = 1.8\text{ }\Omega$; see table 9
Turn-off delay time	$t_{d(off)}$	-	19.7	-	ns	$V_{DD} = 400\text{ V}$, $V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $R_G = 1.8\text{ }\Omega$; see table 9
Fall time	t_f	-	7.0	-	ns	$V_{DD} = 400\text{ V}$, $V_{GS} = 18\text{ V}$, $I_D = 29.5\text{ A}$, $R_G = 1.8\text{ }\Omega$; see table 9

¹⁾ Tested after 1 ms pulse at $V_{GS} = +20\text{ V}$

²⁾ Maximum specification is defined by calculated six sigma upper confidence bound

³⁾ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V

⁴⁾ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400 V

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	13	-	nC	$V_{DD} = 400\text{ V}$, $I_D = 29.5\text{ A}$, $V_{GS} = 0\text{ to }18\text{ V}$
Gate to drain charge	Q_{gd}	-	11	-	nC	$V_{DD} = 400\text{ V}$, $I_D = 29.5\text{ A}$, $V_{GS} = 0\text{ to }18\text{ V}$
Gate charge total	Q_g	-	48	-	nC	$V_{DD} = 400\text{ V}$, $I_D = 29.5\text{ A}$, $V_{GS} = 0\text{ to }18\text{ V}$

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	4.0	-	V	$V_{GS} = 0\text{ V}$, $I_F = 29.5\text{ A}$, $T_J = 25\text{ °C}$
Reverse recovery time	t_{rr}	-	37	-	ns	$V_R = 400\text{ V}$, $I_F = 29.5\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$; see table 8
Reverse recovery charge	Q_{rr}	-	186	-	nC	$V_R = 400\text{ V}$, $I_F = 29.5\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$; see table 8
Peak reverse recovery current	I_{rrm}	-	10.0	-	A	$V_R = 400\text{ V}$, $I_F = 29.5\text{ A}$, $di_F/dt = 1000\text{ A}/\mu\text{s}$; see table 8

4 Electrical characteristics diagrams

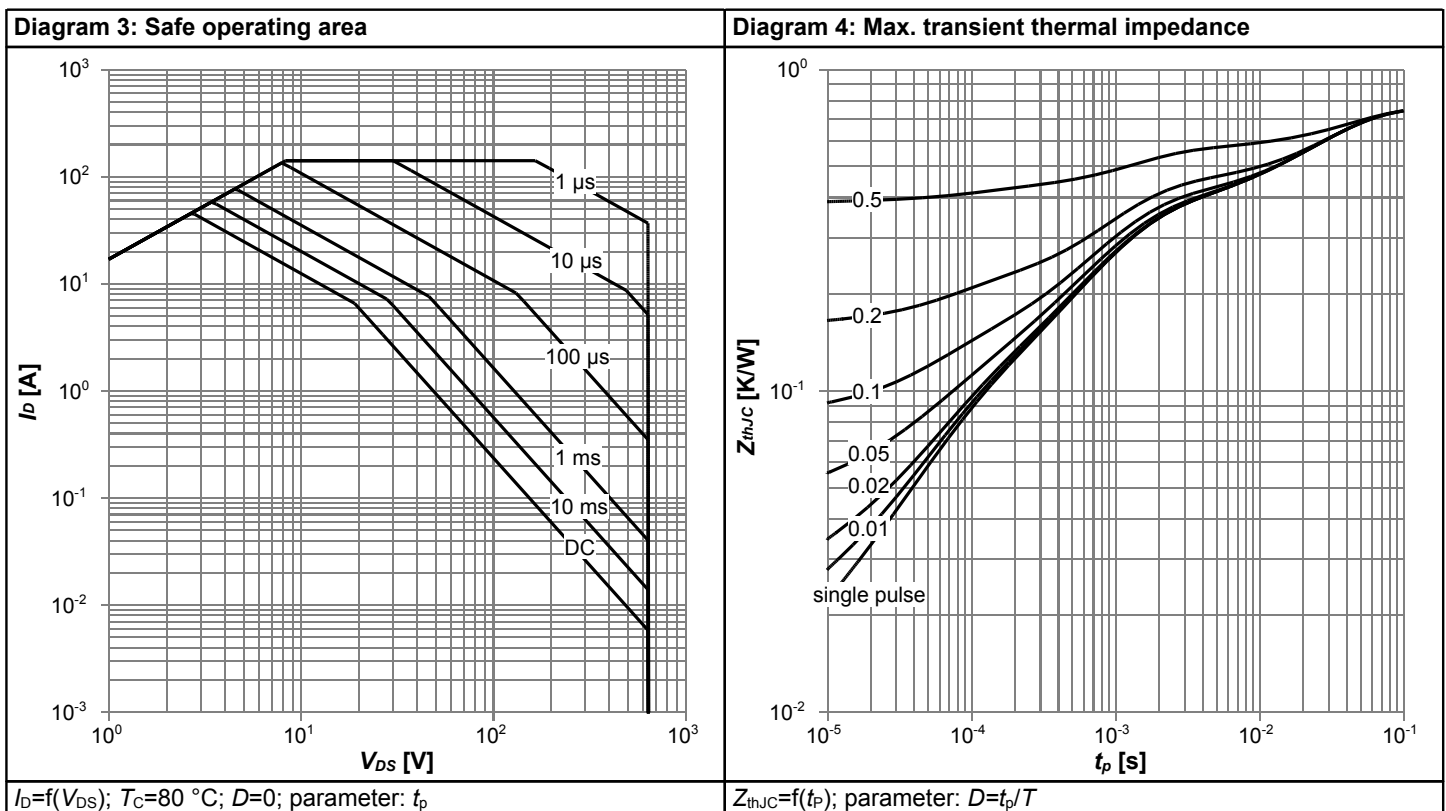
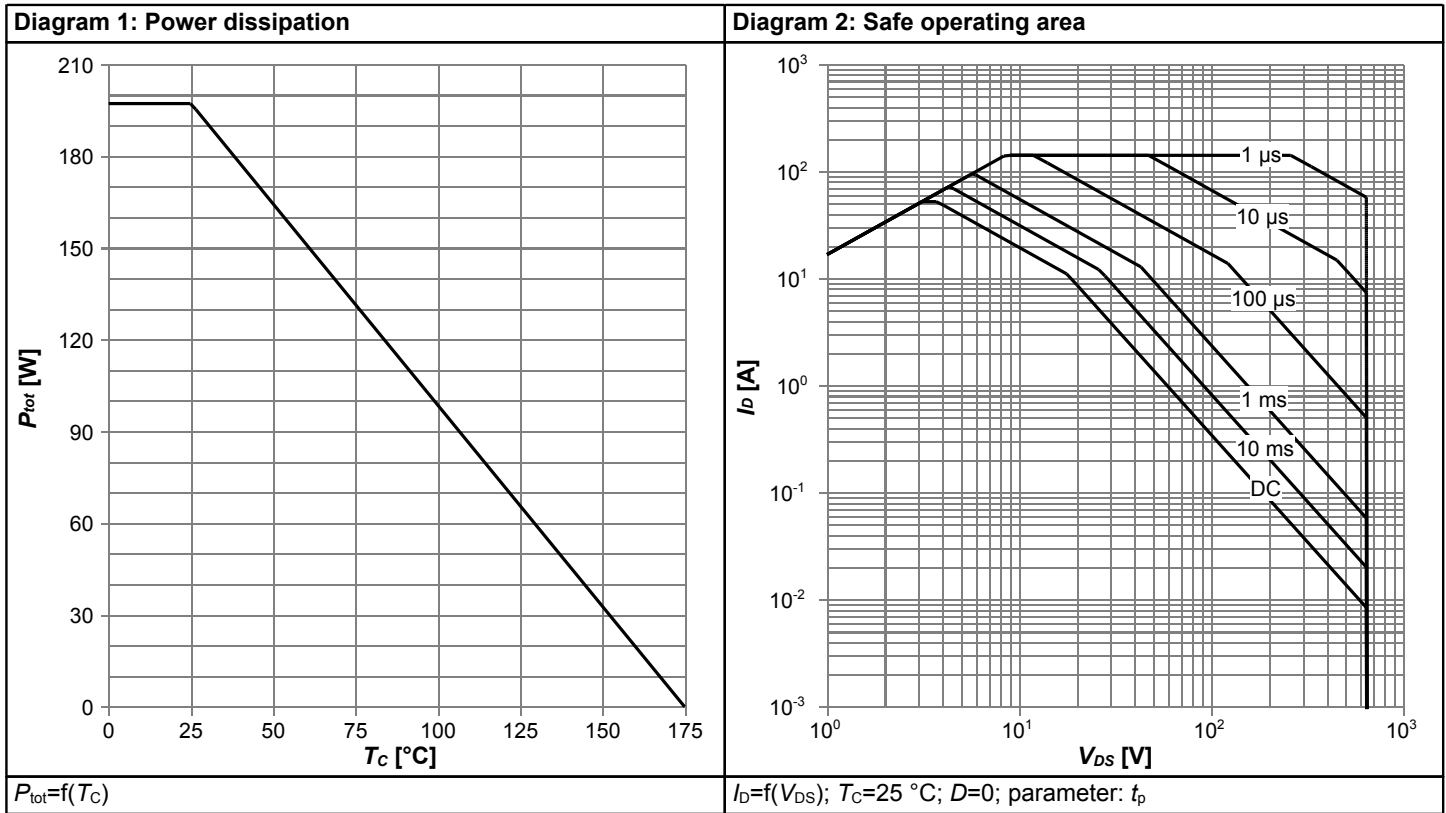
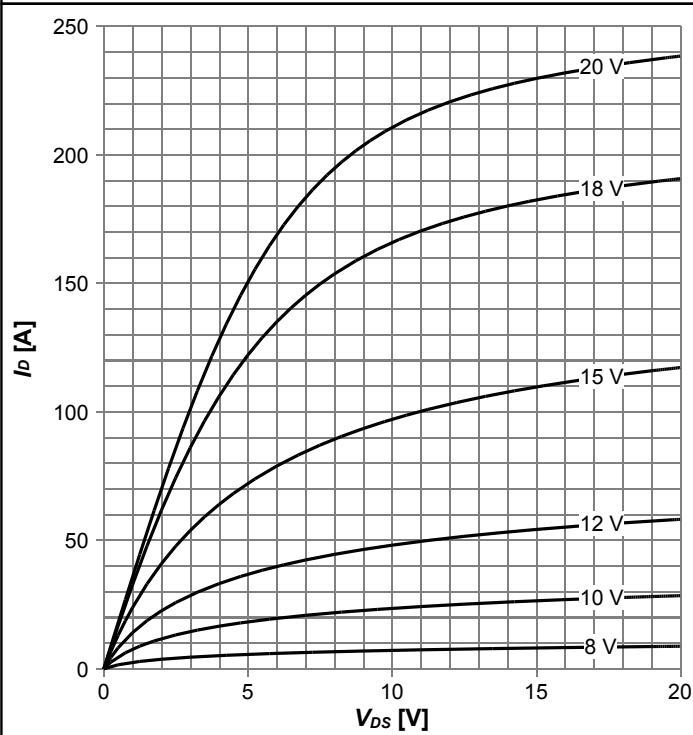
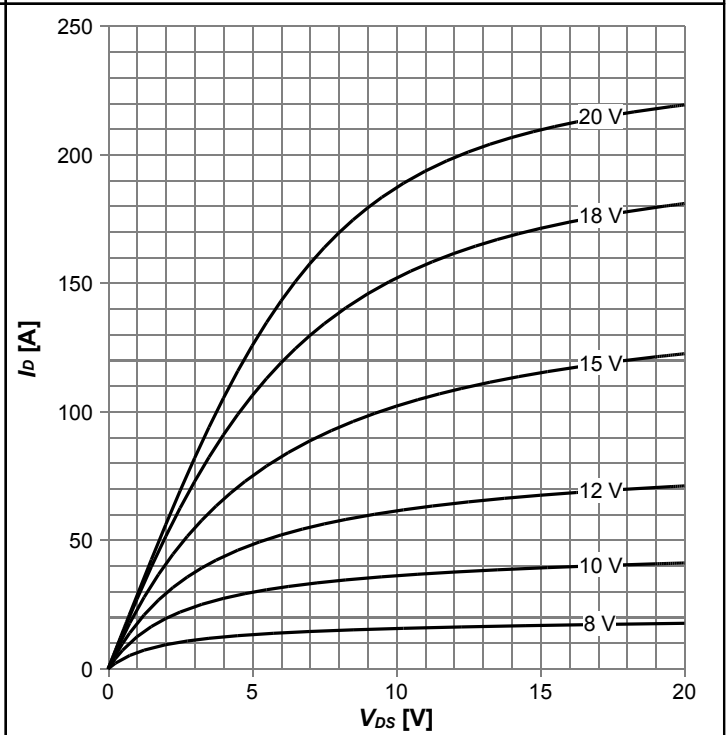


Diagram 5: Typ. output characteristics



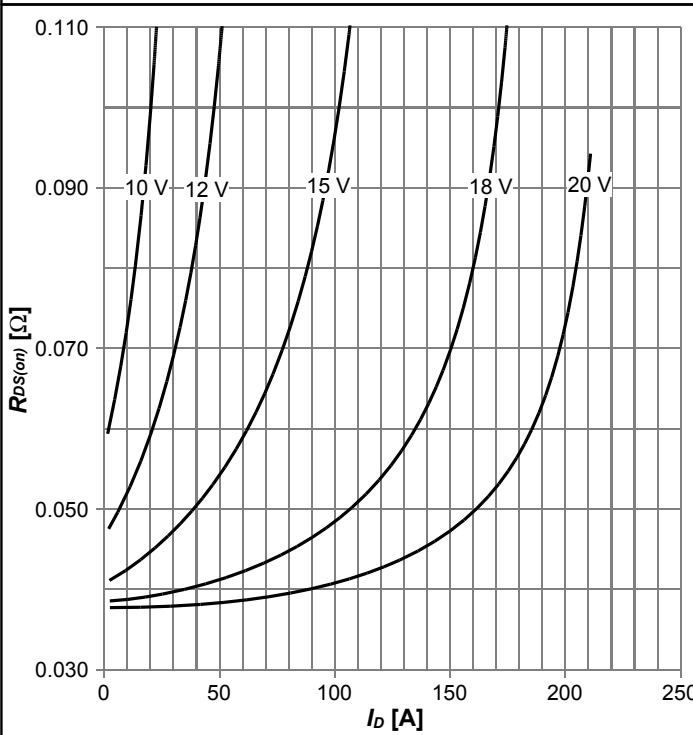
$I_D = f(V_{DS})$; $T_j = 25\text{ °C}$; parameter: V_{GS}

Diagram 6: Typ. output characteristics



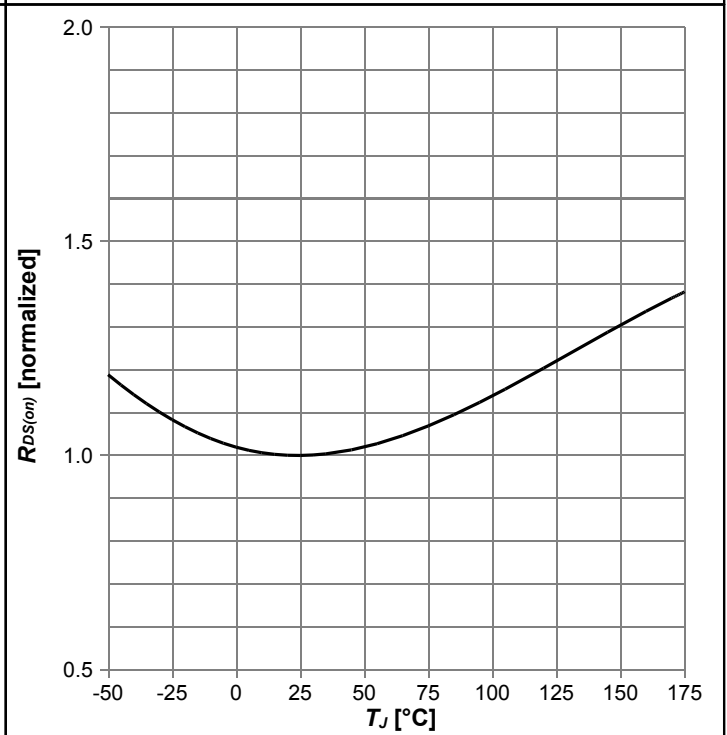
$I_D = f(V_{DS})$; $T_j = 125\text{ °C}$; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



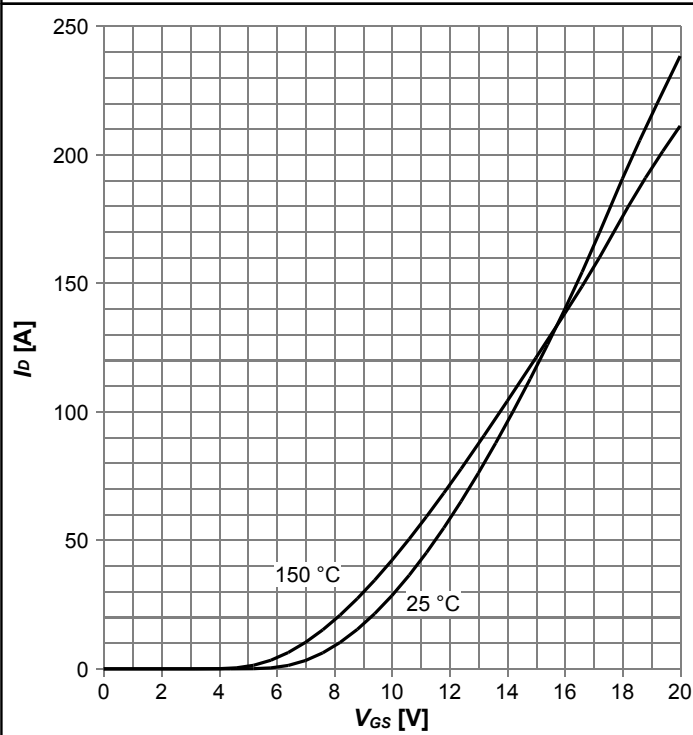
$R_{DS(on)} = f(I_D)$; $T_j = 150\text{ °C}$; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance



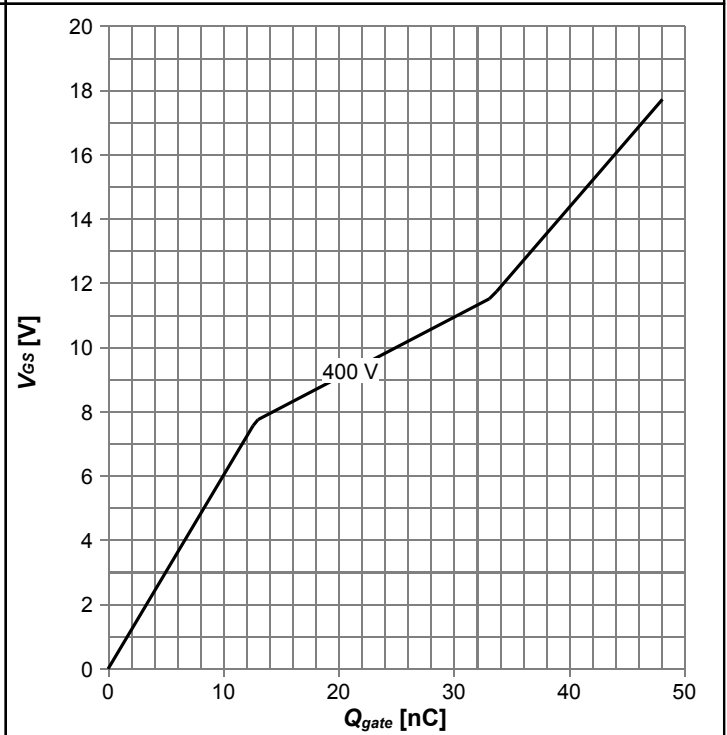
$R_{DS(on)} = f(T_j)$; $I_D = 29.5\text{ A}$; $V_{GS} = 18\text{ V}$

Diagram 9: Typ. transfer characteristics



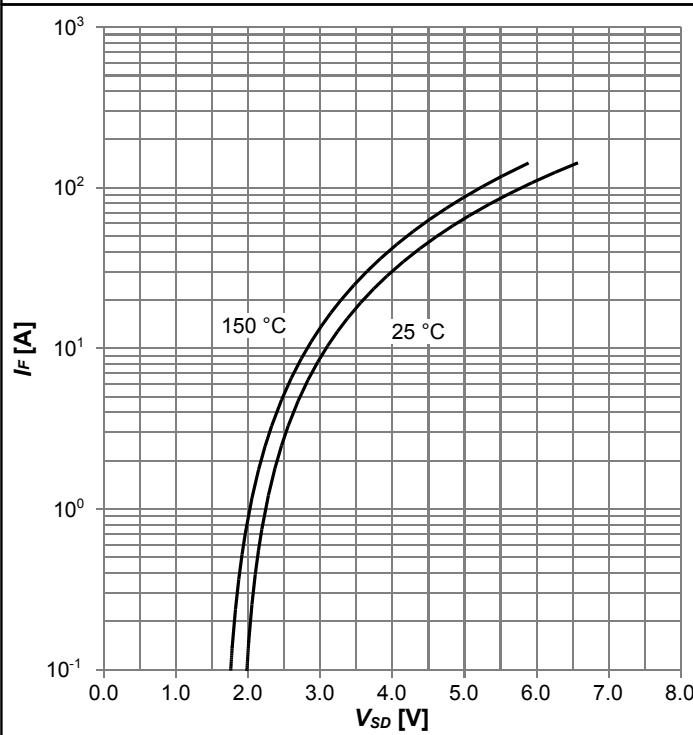
$I_D=f(V_{GS})$; $V_{DS}=20V$; parameter: T_j

Diagram 10: Typ. gate charge



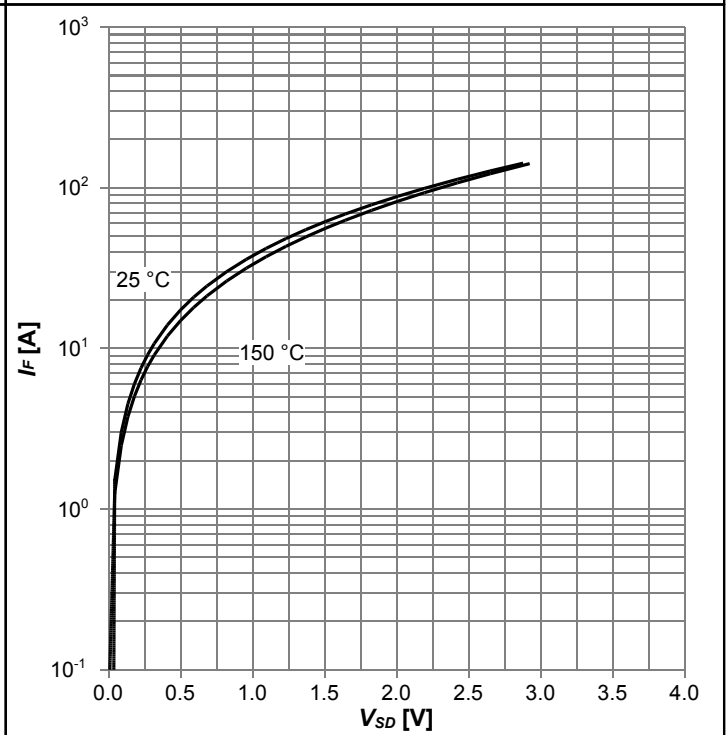
$V_{GS}=f(Q_{gate})$; $I_D=29.5$ A pulsed; parameter: V_{DD}

Diagram 11: Typ. forward characteristics of reverse diode



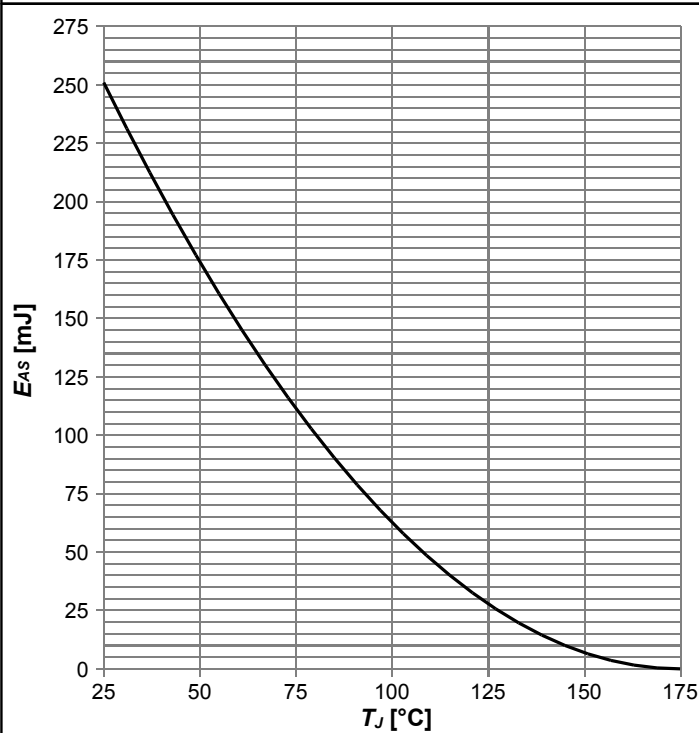
$I_F=f(V_{SD})$; parameter: T_j

Diagram 12: Typ. channel reverse characteristics



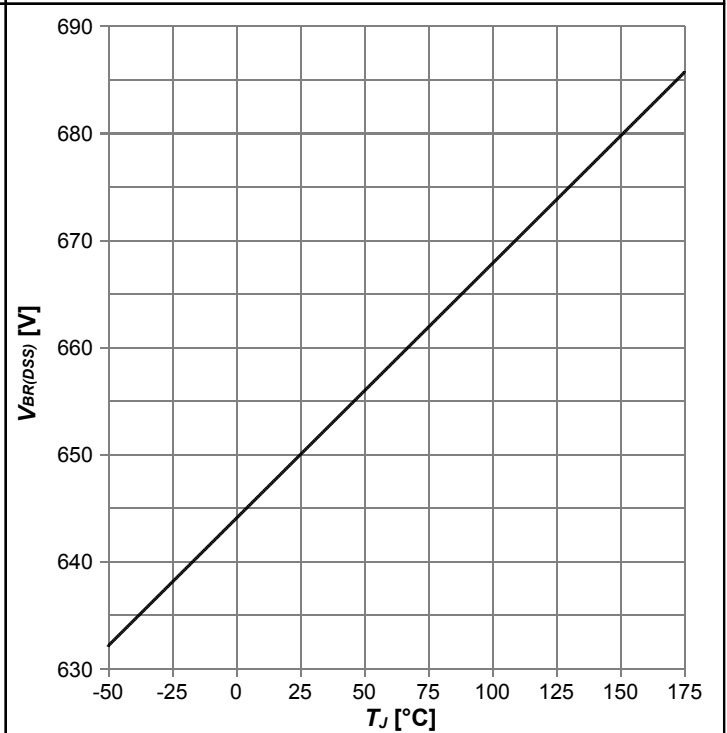
$I_F=f(V_{SD})$; $V_{GS}=18$ V; parameter: T_j

Diagram 13: Avalanche energy



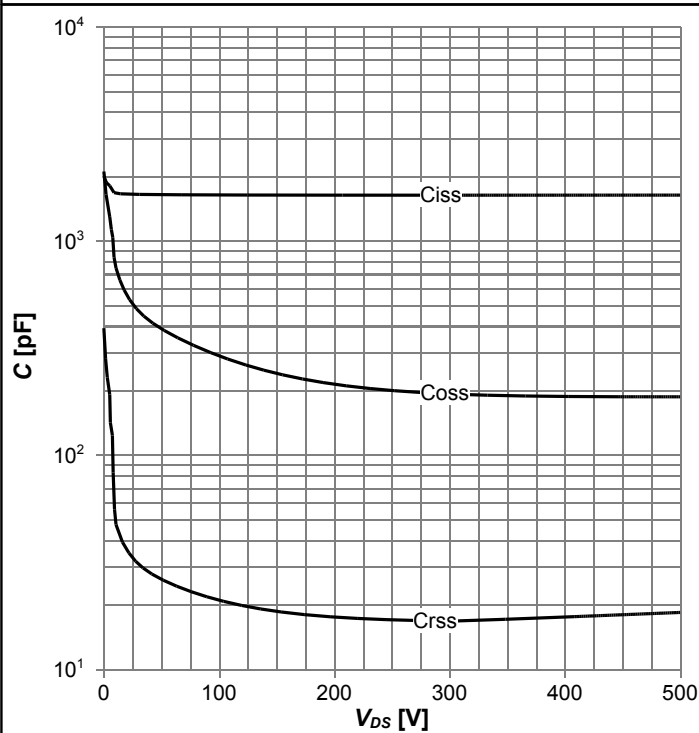
$E_{AS}=f(T_j)$; $I_D=9.4$ A; $V_{DD}=50$ V

Diagram 14: Drain-source breakdown voltage



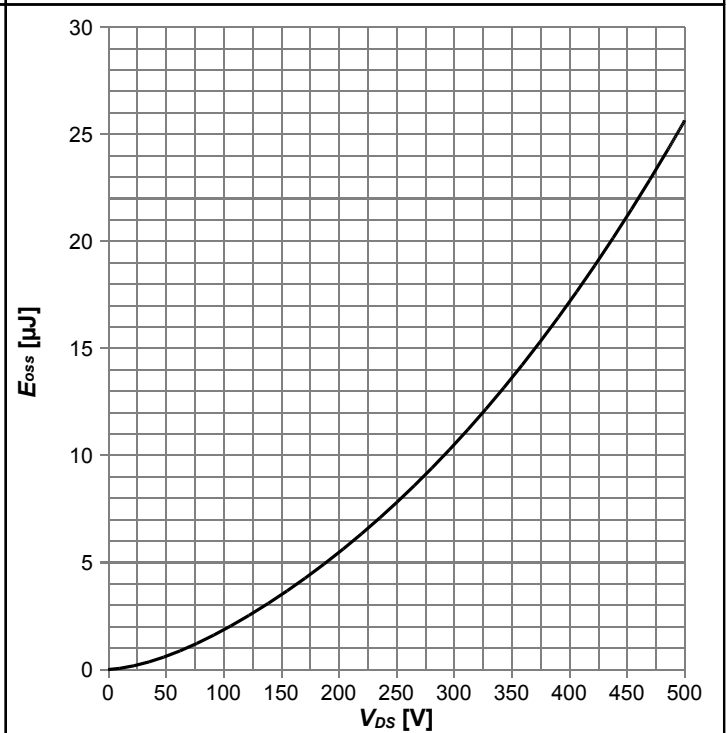
$V_{BR(DSS)}=f(T_j)$; $I_D=0.88$ mA

Diagram 15: Typ. capacitances

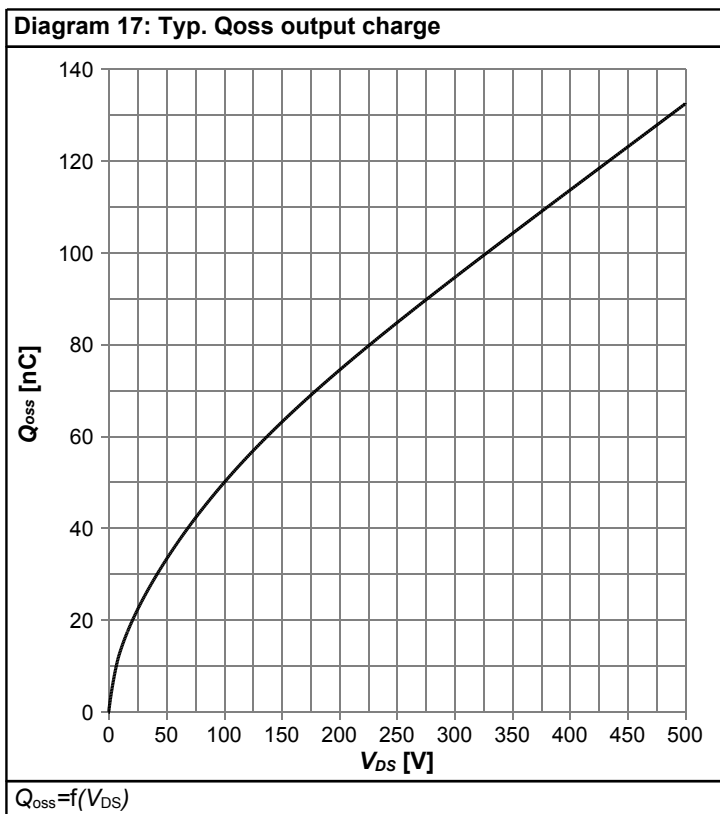


$C=f(V_{DS})$; $V_{GS}=0$ V; $f=250$ kHz

Diagram 16: Typ. Coss stored energy



$E_{oss}=f(V_{DS})$



5 Test Circuits

Table 8 Diode characteristics (ss) (SiC)

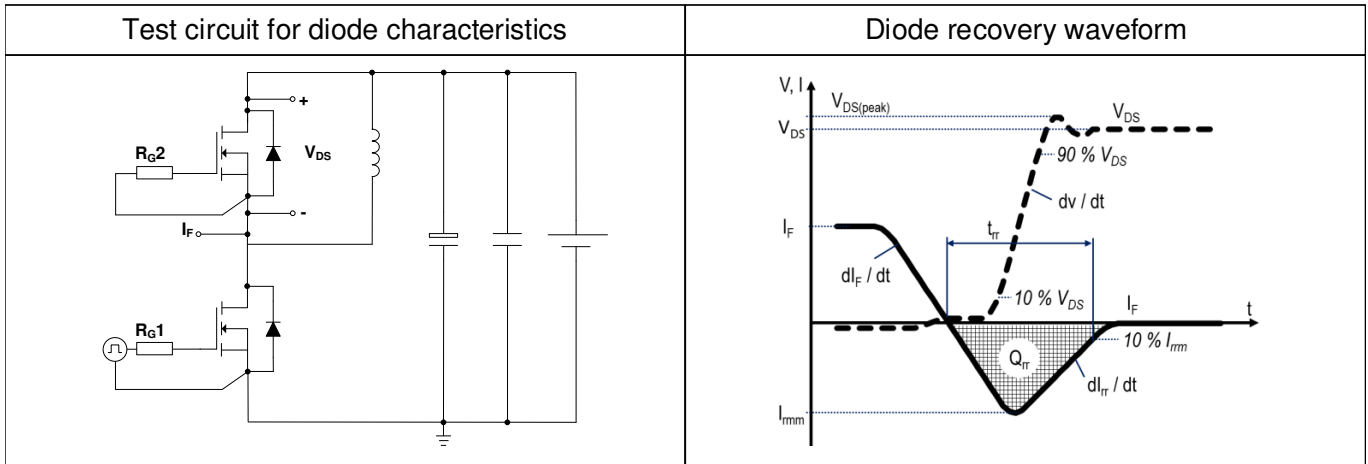


Table 9 Switching times (ss) (SiC)

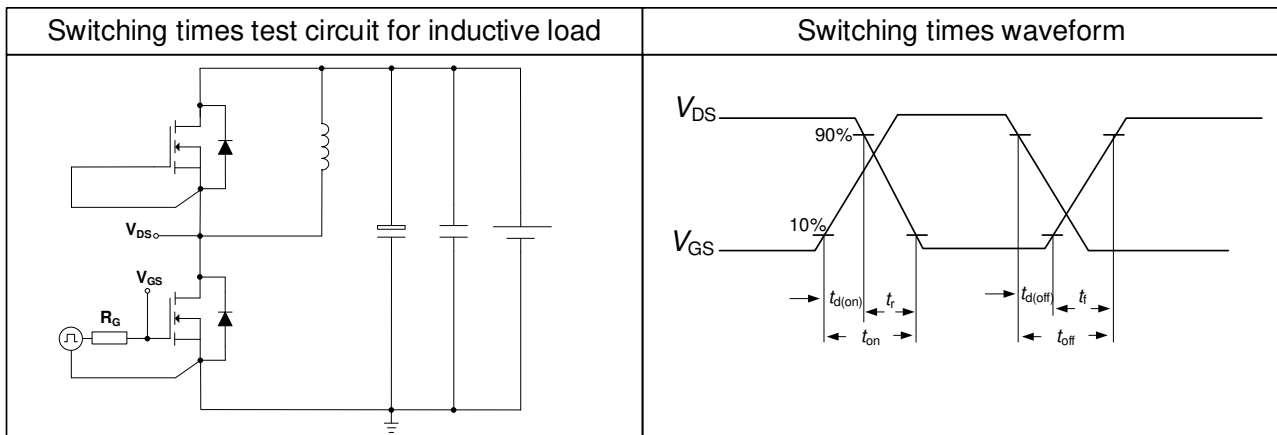
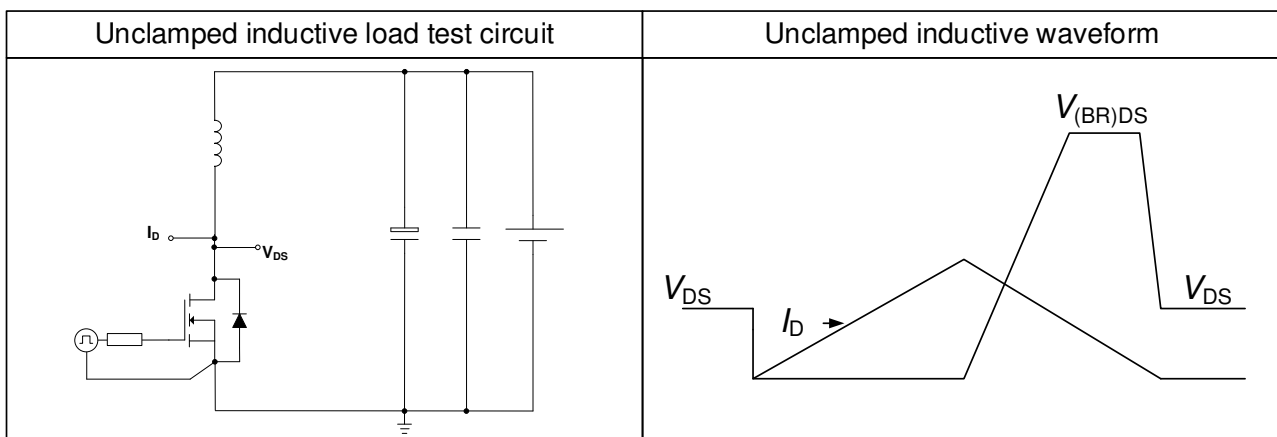
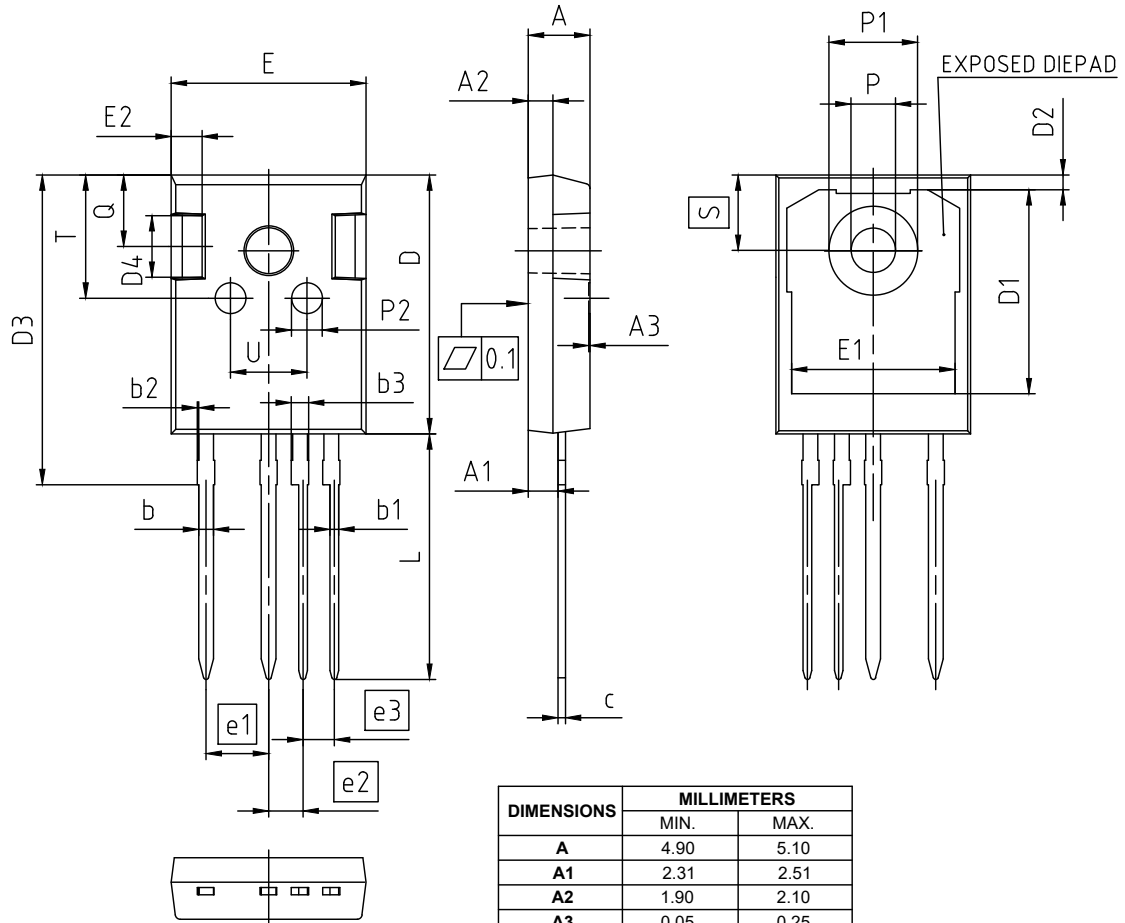


Table 10 Unclamped inductive load (ss) (SiC)



6 Package Outlines



NOTES:
ALL DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

DIMENSIONS	MILLIMETERS	
	MIN.	MAX.
A	4.90	5.10
A1	2.31	2.51
A2	1.90	2.10
A3	0.05	0.25
b	1.10	1.30
b1	0.65	0.79
b2	-	0.20
b3	1.34	1.44
c	0.58	0.66
D	20.90	21.10
D1	16.25	16.85
D2	1.05	1.35
D3	24.97	25.27
D4	4.90	5.10
E	15.70	15.90
E1	13.10	13.50
E2	2.40	2.60
e1	5.08	
e2	2.79	
e3	2.54	
L	19.80	20.10
L1	-	4.30
øP	3.50	3.70
øP1	7.00	7.40
øP2	2.40	2.60
Q	5.60	6.00
S	6.15	
T	9.80	10.20
U	6.00	6.40

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Figure 1 Outline PG-TO247-4-3, dimensions in mm

7 Appendix A

Table 11 Related Links

- IFX CoolSiC M1 Webpage: www.infineon.com
- IFX CoolSiC M1 application note: www.infineon.com
- IFX CoolSiC M1 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com

Revision History

IMZA65R030M1H

Revision: 2021-03-17, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2021-03-17	Release of final version

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[DMWSH120H90SCT7Q](#)